



# N-Channel Super Junction Power MOSFET III

### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

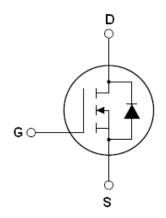
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- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

#### **Application**

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V <sub>DS</sub>	700	V
R <sub>DS(ON)TYP</sub>	680	mΩ
$I_D$	7	A



Schematic diagram

#### **Package Marking And Ordering Information**

Device	Device Package	Marking
NCE70T680I	TO-251	NCE70T680I
NCE70T680K	TO-252	NCE70T680K





TO-251

TO-252

Table 1. Absolute Maximum Ratings ( $T_c=25^{\circ}C$ )

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGS=0V)	V <sub>DS</sub>	700	V
Gate-Source Voltage (V <sub>DS</sub> =0V) ,AC (f>1 Hz)	V <sub>GS</sub>	±30	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	7	А
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	4.5	Α
Pulsed drain current (Note 1)	I <sub>DM (pluse)</sub>	28	Α
Maximum Power Dissipation(Tc=25℃)	P <sub>D</sub>	60	W
Derate above 25°C		0.48	W/°C
Single pulse avalanche energy (Note2)	Eas	101	mJ
Avalanche current <sup>(Note 1)</sup>	I <sub>AR</sub>	1.5	Α
Repetitive Avalanche energy , $t_{\text{AR}}$ limited by $T_{\text{jmax}}$ (Note 1)	E <sub>AR</sub>	0.28	mJ



# NCE70T680I, NCE70T680K

Parameter	Symbol	Value	Unit
Drain Source voltage slope, $V_{DS} \leq 480 \text{ V}$ ,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55+150	°C

#### **Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	$R_{thJC}$	2.08	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	$R_{thJA}$	62	°C /W

Table 3. Electrical Characteristics (TA=25 ℃ unless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
On/off states		L				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	700			V
Zero Gate Voltage Drain Current(Tc=25℃)	I <sub>DSS</sub>	V <sub>DS</sub> =700V,V <sub>GS</sub> =0V			1	μΑ
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =700V,V <sub>GS</sub> =0V			100	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	3		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		680	760	mΩ
Dynamic Characteristics						
Input Capacitance	C <sub>lss</sub>	\/ -50\/\/ -0\/		435		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =50V, $V_{GS}$ =0V, F=1.0MHz		28		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVID2		3.3		pF
Total Gate Charge	$Q_g$	\/ -400\/   -74		11		nC
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> =480V,I <sub>D</sub> =7A,		3.5		nC
Gate-Drain Charge	$Q_{gd}$	- V <sub>GS</sub> =10V		5		nC
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>			8.5		nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =420V,I <sub>D</sub> =3.5A,		7		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G$ =4.7 $\Omega$ , $V_{GS}$ =10 $V$		59	77	nS
Turn-Off Fall Time	t <sub>f</sub>			9.5	16	nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I <sub>SD</sub>	T -25°C			7	Α
Pulsed Source-drain current(Body Diode)	I <sub>SDM</sub>	T <sub>C</sub> =25°C			28	Α
Forward On Voltage	$V_{SD}$	Tj=25°C,I <sub>SD</sub> =7A,V <sub>GS</sub> =0V		0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			210		nS
Reverse Recovery Charge	Q <sub>rr</sub>	Tj=25°C,I <sub>F</sub> =3.5A,di/dt=100A/μs		0.85		uC
Peak Reverse Recovery Current	I <sub>rrm</sub>			8		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R<sub>G</sub>=25 $\Omega$ 





#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

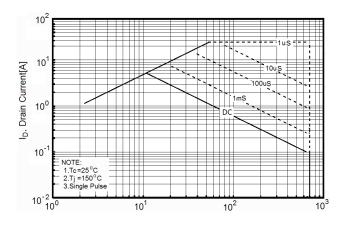


Figure 3. Source-Drain Diode Forward Voltage

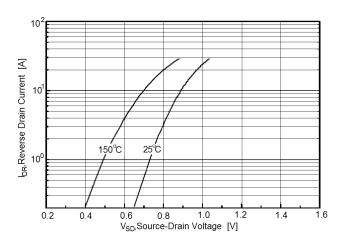


Figure 5. Transfer characteristics

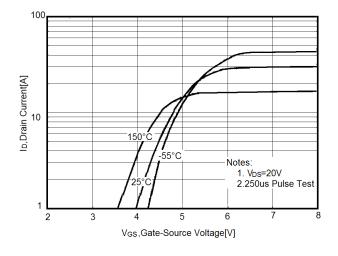


Figure 2. Transient Thermal Impedance

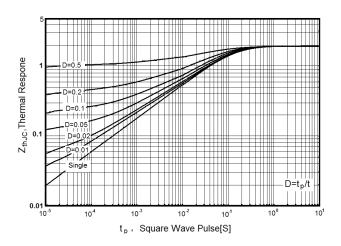


Figure 4. Output characteristics

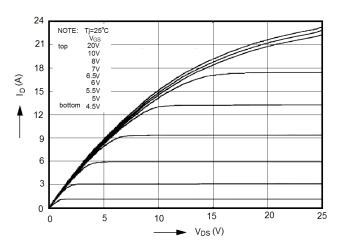
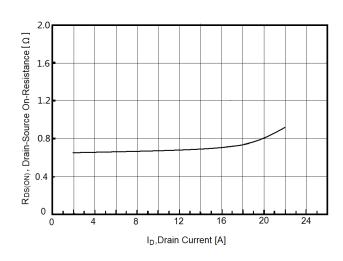


Figure 6. Static drain-source on resistance



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Figure 7. R<sub>DS(ON)</sub> vs Junction Temperature

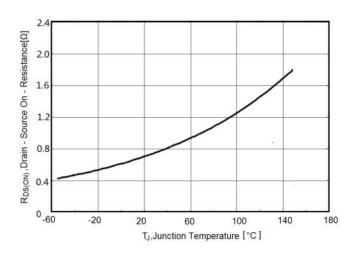


Figure 8. BV<sub>DSS</sub> vs Junction Temperature

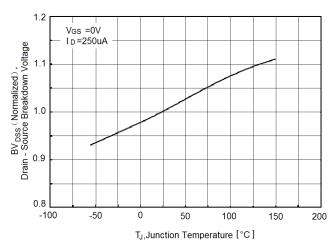


Figure 9. Maximum ID vs Junction Temperature

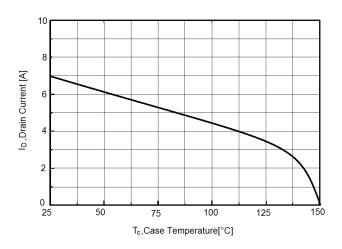


Figure 10. Capacitance

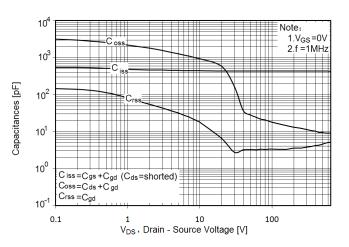
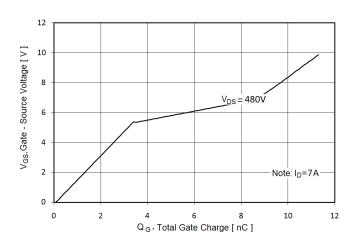


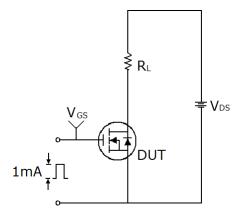
Figure 11. Gate charge waveforms

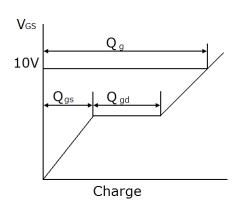




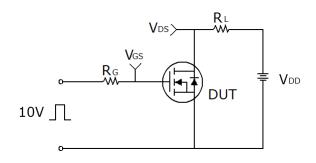
# **Test circuit**

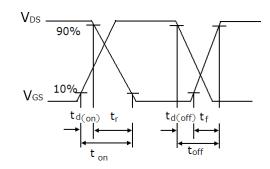
#### 1) Gate charge test circuit & Waveform



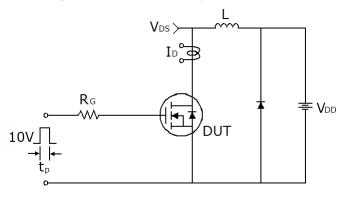


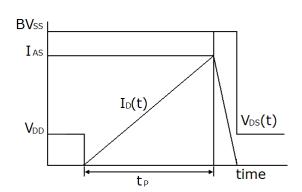
### 2) Switch Time Test Circuit:





# 3) Unclamped Inductive Switching Test Circuit & Waveforms

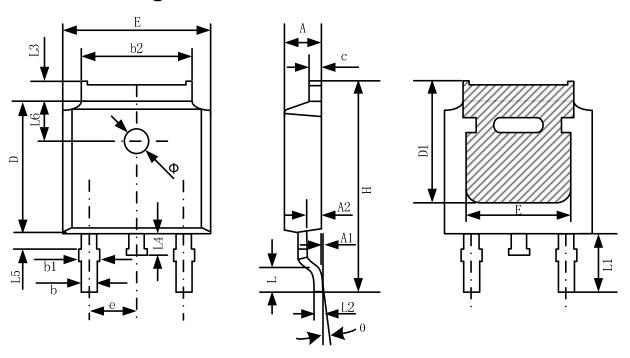




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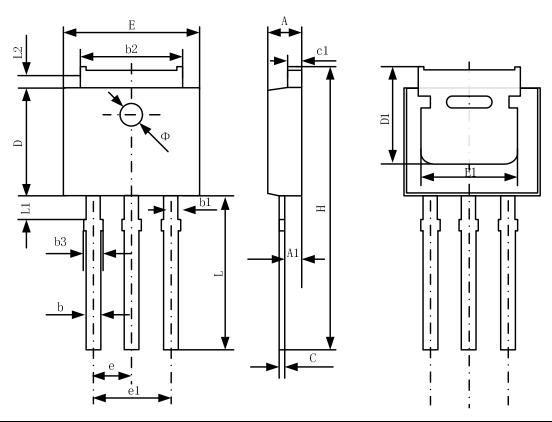
# **TO-252-2 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.20	2.38	0.087	0.094	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25		0.207		
E	6.50	6.70	0.256	0.264	
E1	4.70		0.185		
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.90	) REF	0.11	4 REF	
L2	0.50	BSC 0.020 BSC		0 BSC	
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80	1.80 REF		1 REF	
Ф	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	



# **TO-251 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05		0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
E	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181	0.197	
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	



# NCE70T680I, NCE70T680K

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